## Modules in Mechanics of Materials List of Symbols

A	area, free energy, Madelung constant	
${f A}$	transformation matrix	
$\mathcal A$	plate extensional stiffness	
a	length, transformation matrix, crack length	
$a_T$	time-temperature shifting factor	
B	design allowable for strength	
В	matrix of derivatives of interpolation functions	
$\mathcal B$	plate coupling stiffness	
b	width, thickness	
C	stress optical coefficient, compliance	
$\mathcal C$	viscoelastic compliance operator	
c	numerical constant, length, speed of light	
C.V.	coefficient of variation	
D	stiffness matrix, flexural rigidity of plate	
${\cal D}$	plate bending stiffness	
d	diameter, distance, grain size	
E	modulus of elasticity, electric field	
$E^*$	activation energy	
${\cal E}$	viscoelastic stiffness operator	
e	electronic charge	
$e_{ij}$	deviatoric strain	
F	force	
$f_s$	form factor for shear	
G	shear modulus	
$\mathcal{G}$	viscoelastic shear stiffness operator	
$\mathcal{G}_c$	critical strain energy release rate	
g	acceleration of gravity	
GF	gage factor for strain gages	
H	Brinell hardness	
$h \ I$	depth of beam	
$\mathbf{I}$	moment of inertia, stress invariant identity matrix	
J	polar moment of inertia	
K	bulk modulus, global stiffness matrix, stress intensity factor	
$\mathcal{K}$	viscoelastic bulk stiffness operator	
k	spring stiffness, element stiffness, shear yield stress, Boltzman's constant	
$\stackrel{\kappa}{L}$	length, beam span	
$\mathbf{L}$	matrix of differential operators	
ш	matrix of differential operators	

M bending moment

N crosslink or segment density, moire fringe number, interpolation function, cycles to failure

N traction per unit width on plate

 $N_A$  Avogadro's number

 $\mathcal{N}$  viscoelastic Poisson operator

n refractive index, number of fatigue cycles

n unit normal vectorP concentrated force

 $P_f$  fracture load, probability of failure

 $P_s$  probability of survival

p pressure, moire gridline spacing Q force resultant, first moment of area

q distributed load

R radius, reaction force, strain or stress rate, gas constant, electrical resistance

R Reuter's matrix

r radius, area reduction ratio

S entropy, moire fringe spacing, total surface energy, alternating stress

S compliance matrix

s Laplace variable, standard deviation

SCF stress concentration factor

T temperature, tensile force, stress vector, torque

 $T_q$  glass transition temperature

t time, thickness  $t_f$  time to failure U strain energy

 $U^*$  strain energy per unit volume

UTS ultimate tensile stress

 $\tilde{u}$  approximate displacement function V shearing force, volume, voltage

 $V^*$  activation volume

 $egin{array}{ll} v & ext{velocity} \ W & ext{weight, work} \ \end{array}$ 

u, v, w components of displacement x, y, z rectangular coordinates X standard normal variable  $\alpha, \beta$  curvilinear coordinates

 $\alpha_L$  coefficient of linear thermal expansion

 $\gamma$  shear strain, surface energy per unit area, weight density

 $\delta$  deflection

 $\delta_{ij}$  Kroenecker delta  $\epsilon$  normal strain  $\epsilon$  strain pseudovector  $\epsilon_{ij}$  strain tensor

 $\epsilon_T$  thermal strain  $\eta$  viscosity

 $\theta$  angle, angle of twist per unit length

 $\kappa$  curvature

 $\lambda$  extension ratio, wavelength

	Poisson's ratio
1/	Poisson's ratio

 $\rho$  density, electrical resistivity

 $\Sigma_{ij}$  distortional stress

 $\sigma$  normal stress

 $\sigma$  stress pseudovector

 $\sigma_{ij}$  stress tensor  $\sigma_e$  endurance limit  $\sigma_f$  failure stress  $\sigma_m$  mean stress

 $\sigma_{M}$  Mises stress  $\sigma_{t}$  true stresss  $\sigma_{Y}$  yield stresss

au shear stress, relaxation time

 $\phi$  Airy stress function

 $\begin{array}{ll} \xi & \quad \text{dummy length or time variable} \\ \Omega & \quad \text{configurational probability} \end{array}$ 

 $\begin{array}{ll} \omega & \text{angular frequency} \\ \nabla & \text{gradient operator} \end{array}$ 

## 3.11 Mechanics of Materials Fall 1999

For information about citing these materials or our Terms of Use, visit: http://ocw.mit.edu/terms.